Power MOSFET

40 V, 116 A, Single N–Channel, D²PAK

Features

- Low R_{DS(on)}
- High Current Capability
- Low Gate Charge
- AEC-Q101 Qualified and PPAP Capable NVB5405N
- These Devices are Pb-Free and are RoHS Compliant

Applications

- Electronic Brake Systems
- Electronic Power Steering
- Bridge Circuits

MAXIMUM RATINGS (T_J = 25° C unless otherwise stated)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	40	V
Gate-to-Source Voltage			V _{GS}	±20	V
Continuous Drain	Steady	T _C = 25°C	Ι _D	116	А
Current – $R_{\theta JC}$	State	T _C = 100°C		82	
Power Dissipation – $R_{\theta JC}$	Steady State	$T_{C} = 25^{\circ}C$	P _D	150	W
Continuous Drain	Steady	T _A = 25°C	Ι _D	16.5	Α
Current – $R_{\theta JA}$ (Note 1)	State	T _A = 100°C	Ι _D	11.6	
Power Dissipation – $R_{\theta JA}$ (Note 1)	Steady State	$T_A = 25^{\circ}C$	PD	3.0	W
Pulsed Drain Current	t _p = 10 μs		I _{DM}	280	А
Operating Junction and	perating Junction and Storage Temperature		T _J , T _{STG}	–55 to 175	°C
Source Current (Body Diode) Pulsed			۱ _S	75	А
Single Pulse Drain-to Source Avalanche Energy – (V _{DD} = 50 V, V _{GS} = 10 V, I _{PK} = 40 A, L = 1 mH, R _G = 25 Ω)			EAS	800	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Мах	Unit
Junction-to-Case (Drain)	$R_{\theta JC}$	1.0	°C/W
Junction-to-Ambient (Note 1)	$R_{\theta JA}$	50	°C/W

1. Surface mounted on FR4 board using 1 sq in pad size,

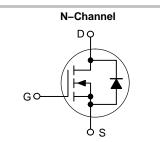
(Cu Area 1.127 sq in [2 oz] including traces).

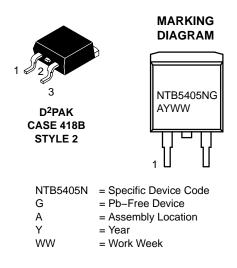


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V _{(BR)DSS}	R _{DS(ON)} TYP	I _D MAX (Note 1)
40 V	4.9 mΩ @ 10 V	116 A





ORDERING INFORMATION

Device	Package	Shipping†
NTB5405NG	D ² PAK (Pb–Free)	50 Units / Rail
NTB5405NT4G	D ² PAK (Pb–Free)	800 / Tape & Reel
NVB5405NT4G	D ² PAK (Pb–Free)	800 / Tape & Reel

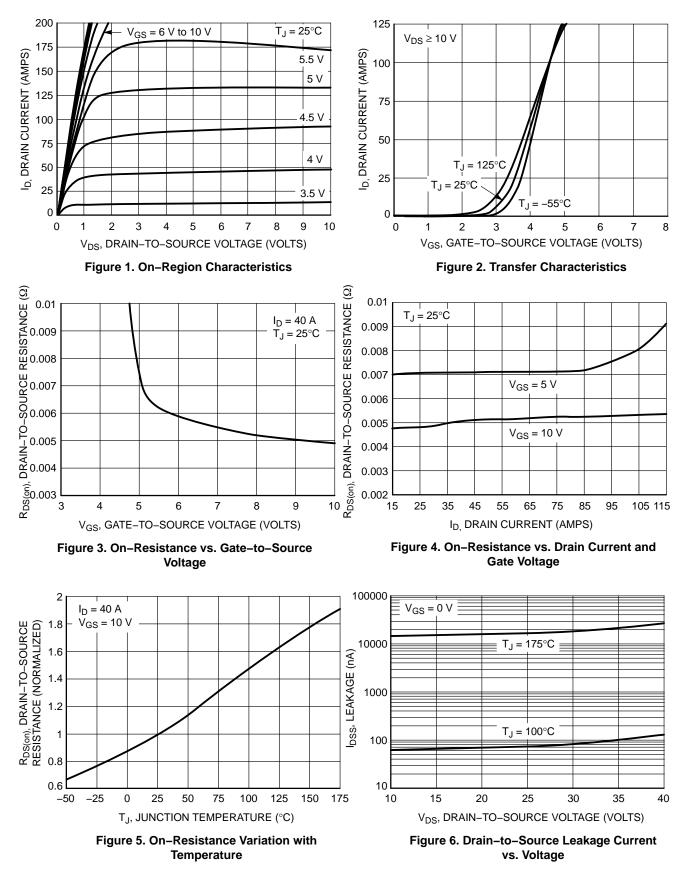
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise stated)

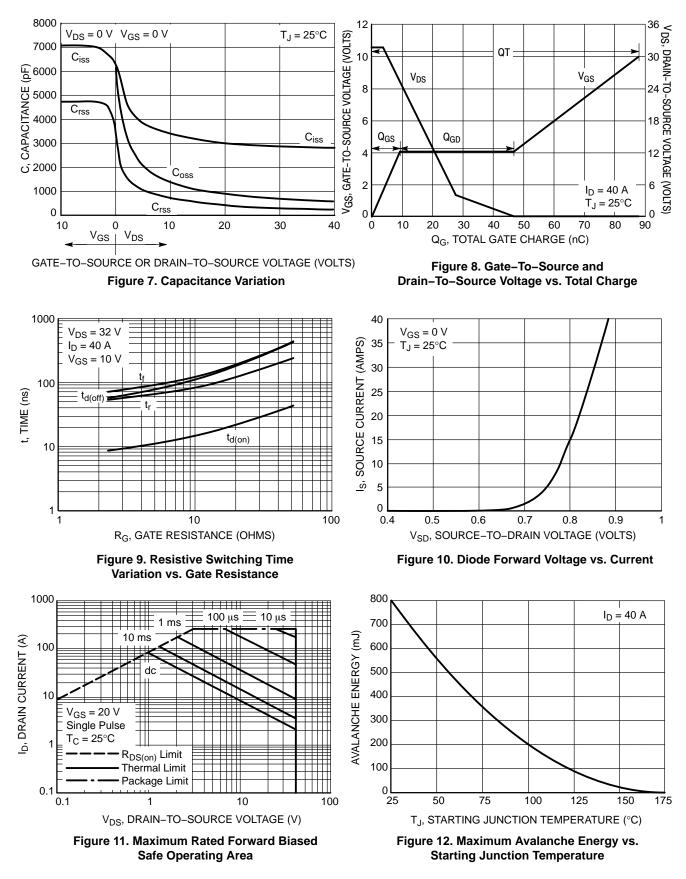
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							-
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = 250 μ A		40			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J				39		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V,$	$T_J = 25^{\circ}C$			1.0	μΑ
		$V_{DS} = 40 V$	$T_J = 100^{\circ}C$			10	
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V, V_{C}$	_{iS} = ±30 V			±100	nA
ON CHARACTERISTICS (Note 2)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_{D}$	= 250 μA	1.5		3.5	V
Gate Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-7.0		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V,	l _D = 40 A		4.9	5.8	mΩ
		$V_{GS} = 5.0 V,$	I _D = 15 A		7.0	8.0	
Forward Transconductance	9 FS	V _{GS} = 10 V,	l _D = 15 A		32		S
CHARGES AND CAPACITANCES							
Input Capacitance	C _{ISS}				2700	4000	pF
Output Capacitance	C _{OSS}	V _{GS} = 0 V, f = V _{DS} = 3	1.0 MHz, 2 V		700	1400	
Reverse Transfer Capacitance	C _{RSS}	. 53 . 5			300	600	
Total Gate Charge	Q _{G(TOT)}				88		nC
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 10 V, V	_{DS} = 32 V,		3.25		
Gate-to-Source Charge	Q _{GS}	$V_{GS} = 10 \text{ V}, \text{ V}_{D}$ $I_{D} = 40$) Ă		9.5		
Gate-to-Drain Charge	Q _{GD}		ſ		37		
SWITCHING CHARACTERISTICS, V_{G}	is = 10 V (Note	3)					
Turn–On Delay Time	t _{d(ON)}	V_{GS} = 10 V, V _{DD} = 32 V, I _D = 40 A, R _G = 2.5 Ω			8.5		ns
Rise Time	t _r				52		
Turn–Off Delay Time	t _{d(OFF)}				55		
Fall Time	t _f				70		
SWITCHING CHARACTERISTICS, V_{G}	s = 5 V (Note 3)					
Turn–On Delay Time	t _{d(ON)}				19		ns
Rise Time	t _r	V _{GS} = 5 V, V _D	_D = 20 V,		153		
Turn–Off Delay Time	t _{d(OFF)}	$I_{\rm D} = 20$ A, $R_{\rm G} = 2.5 \Omega$			32		
Fall Time	t _f				42		
DRAIN-SOURCE DIODE CHARACTE	RISTICS						
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V,	$T_J = 25^{\circ}C$		0.82	1.1	V
		$I_{\rm S} = 20 {\rm A}$	$T_J = 100^{\circ}C$		TBD		
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dI _{SD} /dt = 100 A/μs,			66		ns
Charge Time	t _a				35		
Discharge Time	t _b	I _S = 20		31			
Reverse Recovery Charge	Q _{RR}	1 1			113		nC

Pulse Test: pulse width ≤ 300 μs, duty cycle ≤ 2%.
Switching characteristics are independent of operating junction temperatures.

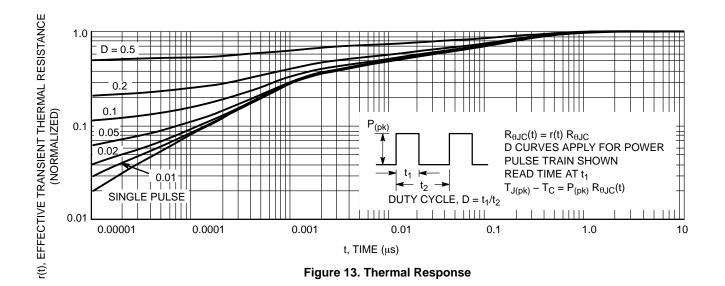
TYPICAL PERFORMANCE CURVES



TYPICAL PERFORMANCE CURVES

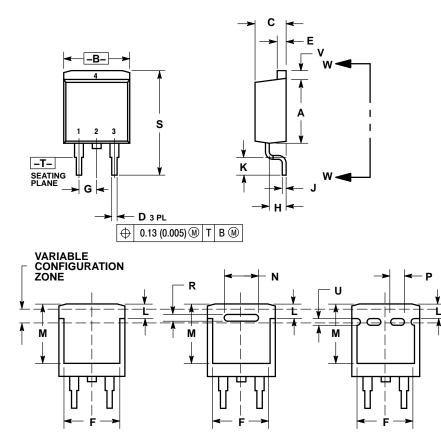


TYPICAL PERFORMANCE CURVES



PACKAGE DIMENSIONS





VIEW W-W

NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3. 418B-01 THRU 418B-03 OBSOLETE, NEW STANDARD 418B-04.

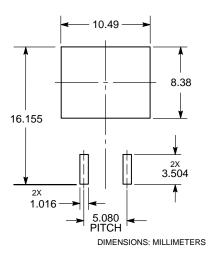
	INCHES		MILLIN	IETERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.340	0.380	8.64	9.65	
В	0.380	0.405	9.65	10.29	
С	0.160	0.190	4.06	4.83	
D	0.020	0.035	0.51	0.89	
Е	0.045	0.055	1.14	1.40	
F	0.310	0.350	7.87	8.89	
G	0.100 BSC		2.54 BSC		
Н	0.080	0.110	2.03	2.79	
J	0.018	0.025	0.46	0.64	
κ	0.090	0.110	2.29	2.79	
L	0.052	0.072	1.32	1.83	
Μ	0.280	0.320	7.11	8.13	
Ν	0.197 REF		5.00	00 REF	
Р	0.079 REF		2.00	2.00 REF	
R	0.039 REF		0.99	99 REF	
S	0.575	0.625	14.60	15.88	
v	0.045	0.055	1.14	1.40	

STYLE 2: PIN 1. GATE 2. DRAIN 3. SOURCE 4. DRAIN

VIEW W–W

SOLDERING FOOTPRINT*

VIEW W-W



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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